

RX Family

R20AN0157EJ0100

Rev.1.00

M3S-SHA-LIB: SHA-1/SHA-256 Library Introduction Guide

Apr 16, 2012

Introduction

This document explains M3S-SHA-LIB: SHA-1/SHA-256 Library for the RX Family (hereafter referred to as "SHA-1/SHA-256 Library") that depends on MCUs.

The SHA-1/SHA-256 Library is the software library incorporated in the RX series. Also it is designed in dedicated algorithm and fully-tuned up by assembly language. Please refer to the User's Manual to know how to use this software library. User's Manual is in installer package.

Target Device

RX Family

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1. Structure of product

SHA-1/SHA-256 Library comprises the following elements.

1. M3S-SHA-LIB: SHA-1/SHA-256 Library for the RX Family V.1.00 Release00E, Installer
2. M3S-SHA-LIB: SHA-1/SHA-256 Library Introduction Guide Rev. 1.00 (r20an0157ej0100_rx_sha.pdf)

part number of this product : R0MRX00QS0010RRC

Table 1 SHA-1/SHA-256 Library product files

name	Description
Installer (setup.exe)	Installer for Windows. Installer will show the Library agreement. If user admits this agreement, installer will copy the file to the path below. [Version for a fee] C:\Renesas\an_r20an0157ej_rx_sha_v100r00p [Evaluation version] C:\Renesas\an_r20an0157ej_rx_sha_v100r00
Library(lib)	
sha_rx600_big.lib	SHA-1/SHA-256 Library file for the RX600 series (big endian)
sha_rx600_little.lib	SHA-1/SHA-256 Library file for the RX600 series (little endian)
sha_rx200_big.lib	SHA-1/SHA-256 Library file for the RX200 series (big endian)
sha_rx200_little.lib	SHA-1/SHA-256 Library file for the RX200 series (little endian)
r_sha.h	SHA-1/SHA-256 Library header file
r_stdint.h	typedef header file
Sample program(sample)	
sha_rx200_sim_sample	SHA-1/SHA-256 sample program (High-performance Embedded Workshop workspace)
Document(doc)	
r20uw0101ej0100_sha.pdf	user's manual
r20an0157ej0100_rx_sha.pdf	Introduction Guide (this document)

Note: When user installs in Windows Vista or Windows 7, Right click the installer (setup.exe) and select the option to "Run as administrator".

2. Specification

2.1 API Function

SHA-1/SHA-256 Library for the RX supports the following functions.

API	Outline
R_Sha1_HashDigest	Generate a SHA-1 hash digest
R_Sha256_HashDigest	Generate a SHA-256 hash digest

2.2 Version information

User can access SHA-1/SHA-256 Library version information with valuable below.

```
extern const char R_sha_version[];
```

```
SHA-1/SHA-256 Library file for the RX600 series (big endian)
```

```
"M3S-SHA-LIB version 1.00 for RX600 BIG endian.(Mar 16 2012, 16:56:11)"
```

```
SHA-1/SHA-256 Library file for the RX600 series (little endian)
```

```
"M3S-SHA-LIB version 1.00 for RX600 LITTLE endian.(Mar 16 2012, 16:56:17)"
```

```
SHA-1/SHA-256 Library file for the RX200 series (big endian)
```

```
"M3S-SHA-LIB version 1.00 for RX200 BIG endian.(Mar 16 2012, 16:55:57)"
```

```
SHA-1/SHA-256 Library file for the RX200 series (little endian)
```

```
"M3S-SHA-LIB version 1.00 for RX200 LITTLE endian.(Mar 16 2012, 16:56:06)"
```

2.3 Section

Section Name	Location	Content
P	Program area	Library code
C	Constant area	Constant data
SU	User stack area	Stack
SI	Interrupt stack area	Stack

2.4 SHA-1/SHA-256 Library ROM / RAM / stack size / cycles

2.4.1 ROM/RAM size

library file name	ROM size [byte]	RAM size [byte]
sha_rx600_big.lib	11555	0
sha_rx600_little.lib	11633	0
sha_rx200_big.lib	11555	0
sha_rx200_little.lib	11633	0

2.4.2 stack size

API	stack size [byte]
R_Sha1_HashDigest	168
R_Sha256_HashDigest	180

Note: stack size is same in all library.

2.4.3 cycles

input message length[byte]	SHA-1 [cycles]	SHA-256 [cycles]
0	about 5500	about 5100
64	about 10200	about 9200
128	about 14900	about 13300
192	about 19500	about 17400
256	about 24200	about 21500

Note: Input message is 1 block with padding processing.

2.5 Development environment

[Host OS]

Windows XP SP3

[Software]

When user develops, choose newer version than below.

-Integrated Development Environment

High Performance Embedded Workshop Version 4.09.00.007

-C compiler

C/C++ Compiler Package for RX Family V.1.01 Release 00

-Debugger

(RX600 series)

RX Family Simulator/Debugger V.1.02.00.005

RX600 Simulator Target Platform V.1.02.00.005

(RX200 series)

RX Family Simulator/Debugger V.1.02.00.005

RX200 Simulator Target Platform V.1.00.00.001

2.6 Compiler option for generating library

Libraryfile is built with the following options.

- SHA-1/SHA-256 Library file for the RX600 series (big endian)
 - Compiler Options
 - cpu=rx600 -endian=big -include="\$(WORKSPDIR)\..\src\library_header" -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 - Assembler Options
 - cpu=rx600 -endian=big -output="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 - Optimizing Linkage Editor Options
 - noprelink -form=library -nomessage -list="\$(CONFIGDIR)\\$(PROJECTNAME).lbp" -nologo -output="\$(CONFIGDIR)\\$(PROJECTNAME).lib" -exit
- SHA-1/SHA-256 Library file for the RX600 series (little endian)
 - Compiler Options
 - cpu=rx600 -include="\$(WORKSPDIR)\..\src\library_header" -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 - Assembler Options
 - cpu=rx600 -output="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 - Optimizing Linkage Editor Options
 - noprelink -form=library -nomessage -list="\$(CONFIGDIR)\\$(PROJECTNAME).lbp" -nologo -output="\$(CONFIGDIR)\\$(PROJECTNAME).lib" -exit
- SHA-1/SHA-256 Library file for the RX200 series (big endian)
 - Compiler Options
 - cpu=rx200 -endian=big -include="\$(WORKSPDIR)\..\src\library_header" -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 - Assembler Options
 - cpu=rx200 -endian=big -output="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 - Optimizing Linkage Editor Options
 - noprelink -form=library -nomessage -list="\$(CONFIGDIR)\\$(PROJECTNAME).lbp" -nologo -output="\$(CONFIGDIR)\\$(PROJECTNAME).lib" -exit
- SHA-1/SHA-256 Library file for the RX200 series (little endian)
 - Compiler Options
 - cpu=rx200 -include="\$(WORKSPDIR)\..\src\library_header" -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 - Assembler Options
 - cpu=rx200 -output="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
 - Optimizing Linkage Editor Options
 - noprelink -form=library -nomessage -list="\$(CONFIGDIR)\\$(PROJECTNAME).lbp" -nologo -output="\$(CONFIGDIR)\\$(PROJECTNAME).lib" -exit

3. Limitations

- This library cannot be used except Microcontroller Options `fint_register=0` (Fast interrupt vectorregister [None]). The default for this option is `fint_register=0`.

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Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Apr.16.12	—	First edition issued

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable.

When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.

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